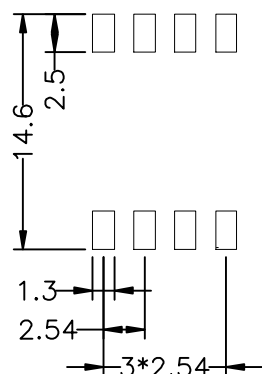
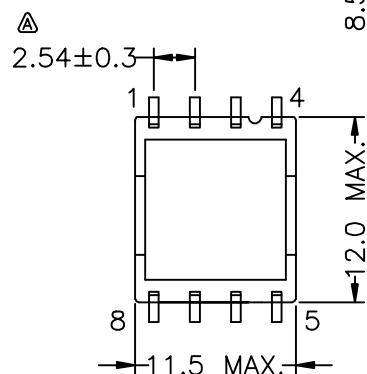
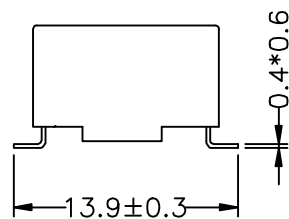
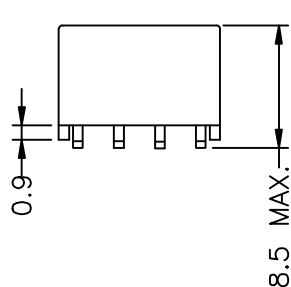


ELECTRICAL CHARACTERISTICS :

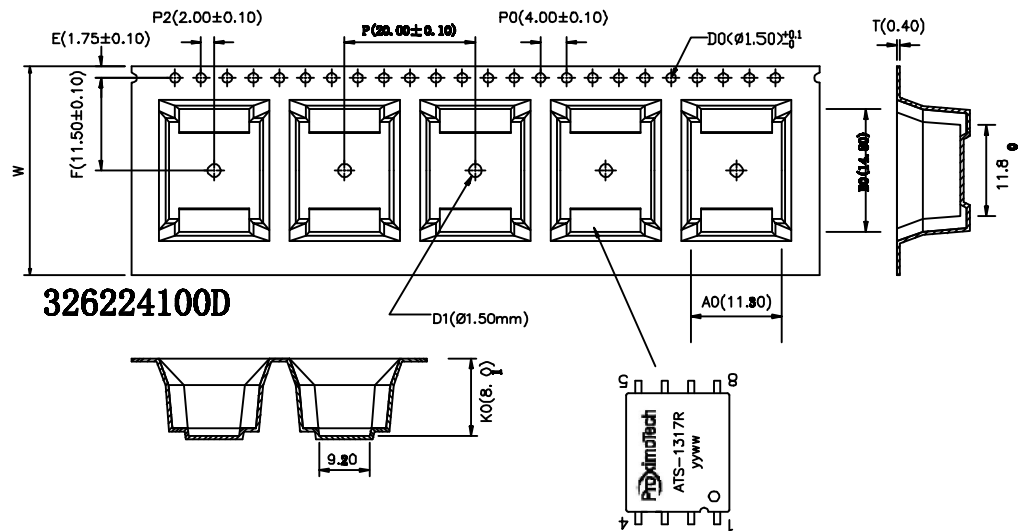
- DCR : PIN 1-2 = 190mΩ MAX.
PIN 3-4 = 190mΩ MAX.
PIN 5-6 = 200mΩ MAX.
PIN 7-8 = 280mΩ MAX.
- INDUCTANCE (@10KHz, 100mVrms)
PIN 1-4 (PIN 2-3 SHORT) = 45uH MIN.
- LEAKAGE INDUCTANCE (@200KHz, 0.1Vrms)
PIN 1-4 (PIN 2.3 SHORT, PIN 5.6.7.8 SHORT) = 500nH MAX.
- INTERWINDING CAPACITANCE (@10KHz, 0.1Vrms)
PIN 1-8 (PIN 2-3,6-7 SHORT) = 8.0pF MAX.
- TURN RATIO (@100KHz, 0.1Vrms)
PIN 1-4 (PIN 2-3 SHORT) : 6-5 = 1.5 ±2%
PIN 1-4 (PIN 2-3 SHORT) : 8-7 = 1 ±2%
- HI-POT (@3750VAC, 5mA, 1SEC)
PIN 1 (PIN 2-3 SHORT) - PIN 8 (PIN 6-7 SHORT)
- PRIMARY TO SECONDARY CLEARANCE 4.5mm MIN.
PRIMARY TO SECONDARY CREEPAGE 5.1mm MIN.
- RoHS COMPLIANT



Unit:mm

SUGGESTED PCB LAYOUT

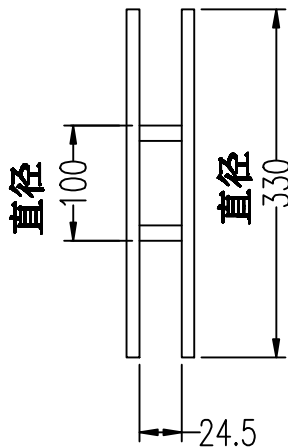
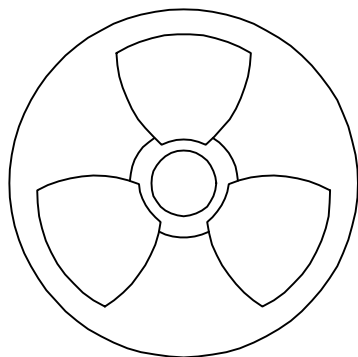
								TITLE Transformer	
								DWG. NO. PL-069R	
A	ADD PIN TOLERANCE	07/15/2022	SHIRLEY	RONAN	RONAN	UNITS:	SAFETY		SHEET 1 OF 1
	RELEASE	04/10/2019	SHIRLEY	RONAN	RONAN	M/M			
NO:	DESCRIPTION	DATE	BY	CHK	APPD	DATE	P/N:	DRAW	
REVISIONS						04/10/19	SHIRLEY		



326224100D

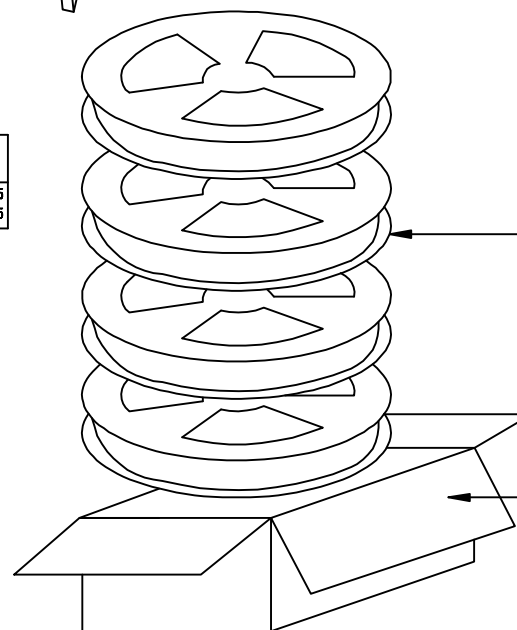
3240300009 or
3240300001
(PK-045)*2PCS
(SPONGE)

ITEM	W	A ₀	B ₀	K ₀	P	F	E	D ₀	D ₁	P ₀	P ₂	T
DIM	24.0 ^{+0.30} _{-0.10}	11.30 ^{+0.10} _{-0.10}	14.80 ^{+0.10} _{-0.10}	8.10 ^{+0.10} _{-0.10}	20.00 ^{+0.10} _{-0.10}	11.50 ^{+0.10} _{-0.10}	1.75 ^{+0.10} _{-0.10}	1.50 ^{+0.10} _{-0.00}	1.50 ^{+0.10} _{-0.00}	4.00 ^{+0.10} _{-0.10}	2.00 ^{+0.10} _{-0.10}	0.40 ^{+0.05} _{-0.05}



REEL

ONE REEL 400PCS
ONE CARTON 4 REEL (1600PCS)
每卷放干燥包1PCS用真空袋抽真空封口
2780000000 3255048421 OR
3255048420



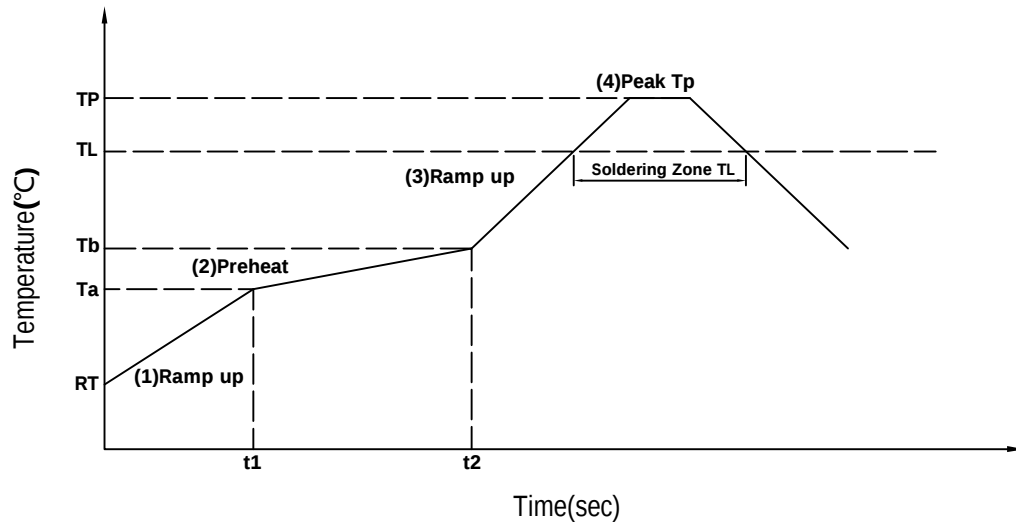
3260240005
(PK-055)*4PCS
(REEL)

3213434003
(PK-071A)*1PCS
(CARTON)

								TITLE PACKING	
								DWG. NO. 968S131700	
	RELEASE	02/08/2014	SHIRLEY	JOAN	JOAN	UNITS: M/M	SAFETY		SHEET 1 OF 1
NO:	DESCRIPTION	DATE	BY	CHK	APPD	DATE 01/08/14	P/N:		DRAW Shirley
REVISIONS									



Pb-free Soldering IR Reflow(SMD)



- 1,MSL Grade: 1 Level 2,Floor life: 2years 3,Condition:≤30°C RH 85%
2,Form-1(Reference JEDEC J-STD-020D Table 5-2)

IR reflow profile		Pb-free
step#	Profile Feature	Condition/Duration
step1	Ramp-up rate	3°C/second max
step2	Preheat:150°C-200°C(Ta-Tb)	t1-t2:60-120seconds
step3	Ramp-up rate(TL to Tp)	3°C/second max
	Temperature maintained above 217°C	60-150seconds
step4	Peak temperature(Tp)	260+0/-5°C
	Time within 5°C of actual peak temperature	30seconds max
Ramp-down rate(Tp to TL)		6°C/second max

- 3,Form-2(Reference JEDEC J-STD-020D Table 4-2)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
<1.6mm	260+0/-5°C	260+0/-5°C	260+0/-5°C
1.6mm-2.5mm	260+0/-5°C	250+0/-5°C	245+0/-5°C
>2.5mm	250+0/-5°C	245+0/-5°C	245+0/-5°C